

3679

## AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Seungbae Park et al

Docket No.

EN999048D

Serial No.  
10/038,264Filing Date  
1/3/02Examiner  
Ernest GarciaGroup Art Unit  
3679

Invention: SOLDER INTERCONNECT TECHNIQUE

COPY OF PAPERS  
ORIGINALLY FILED

## TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

## CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS.	4	20 =	0	x \$18.00	\$0.00
INDEP. CLAIMS	3	5 =	0	x \$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

No additional fee is required for amendment.  
 Please charge Deposit Account No. \_\_\_\_\_ in the amount of \_\_\_\_\_.  
 A duplicate copy of this sheet is enclosed.  
 A check in the amount of \_\_\_\_\_ to cover the filing fee is enclosed.  
 The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 09-0457  
 A duplicate copy of this sheet is enclosed.  
 Any additional filing fees required under 37 C.F.R. 1.16.  
 Any patent application processing fees under 37 CFR 1.17.

Signature

Dated: 7/22/02

RECEIVED

JUL 26 2002

GROUP 3600

I certify that this document and fee is being deposited on 7/22/02 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Signature of Person Mailing Correspondence

Mark Levy

Typed or Printed Name of Person Mailing Correspondence

CC: